

SMB1N-515V-02

- Green High Power LED
- 515 nm, 250 mW
- SMD package, PA9T
- Dimension: 5.0 x 5.2 x 5.5 mm
- Viewing Angle: 18°

Description





v 1.1 17.07.2014

SMB1N-515V-02 is a surface mount InGaN High Power LED with a typical peak wavelength of 515 nm and radiation of 250 mW. It comes in SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and molded with silicone resin.

Maximum Ratings (T_{CASE}=25°C)

Parameter	Symbol	Val	Unit		
Farameter	Symbol	Min.	Max.	Unit	
Power Dissipation	PD		1300	mW	
Forward Current	IF		350	mA	
Pulse Forward Current *1	I _{FP}		1000	mA	
Reverse Voltage	VF		5	V	
Thermal Resistance	R _{THJA}		10	K/W	
Junction Temperature	T_J		120	°C	
Operating Temperature	T _{CASE}	- 40	+ 100	°C	
Storage Temperature	T _{STG}	- 40	+ 100	°C	
Lead Solder Temperature *2	T _{SLD}		+ 250	°C	

 *1 duty=1%, pulse width = 10 μs *2 must be completed within 5 seconds

Electro-Optical Characteristics $(T_{CASE}=25^{\circ}C)$

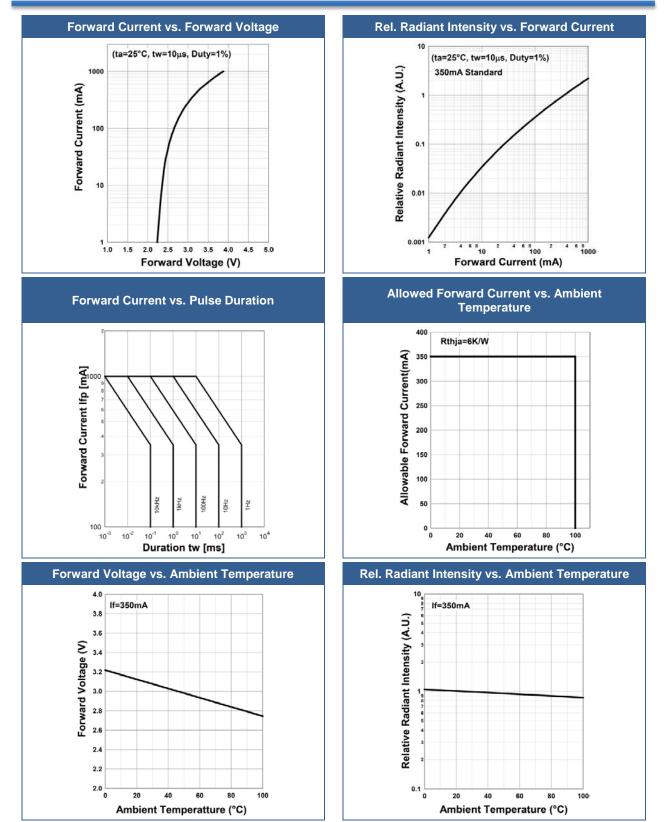
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λ_P	I _F =350mA	505	515	525	nm
Half Width	$\Delta \lambda$	I _F =350mA		29		nm
Dominant Wavelength	λ_D	I _F =350mA		530		nm
Forward Voltage	V_F	I _F =350mA		3.1	3.6	V
	V _{FP}	I _{FP} =1A		3.9		
Radiated Power *1	Po	I _F =350mA		250		mW
	r ₀	I _{FP} =1A		550		
Radiant Intensity *2	,	I _F =350mA		300		mW/sr
	IE	I _{FP} =1A		600		
Brigthness	,	I _F =350mA		290		cd
	I_V	I _{FP} =1A		640		
Viewing Angle	φ	I _F =100mA		18		deg.
Rise Time	t _R	I _F =350mA		50		ns
Fall Time	t _F	I _F =350mA		100		ns

*¹ measured by S3584-08

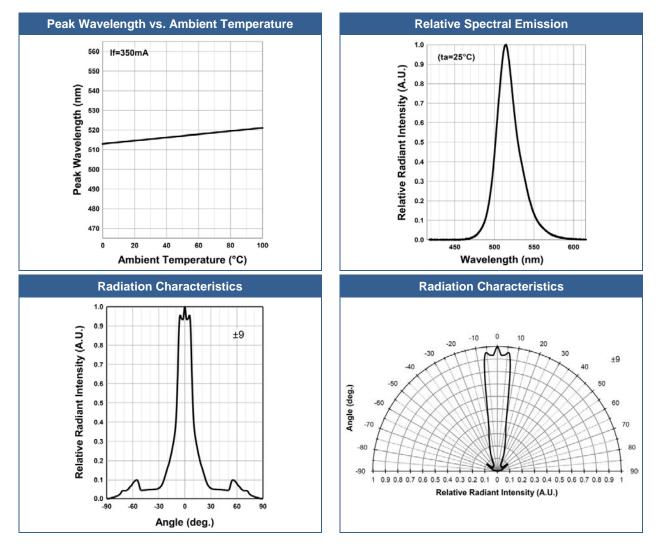
*² measured by CIE127-2007 Condition B



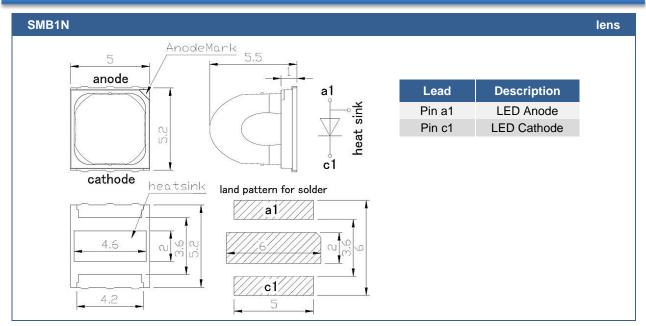
Typical Performance Curves







Outline Dimensions



All Dimensions in mm



Precautions

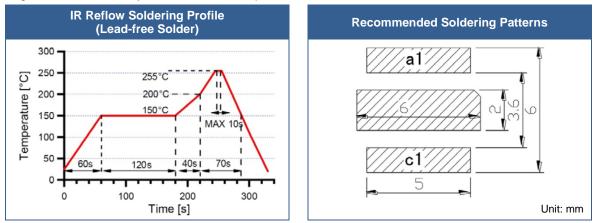
Soldering:

- Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- · Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering

Recommended soldering conditions:

This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, its reliability cannot be guarantee.

Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.



Above table specifies the maximum allowed duration and temperature during soldering. It is strongly advised to perform soldering at the shortest time and lowest temperature possible.

Cleaning:

Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended

DO NOT USE acetone, chloroseen, trichloroethylene, or MKS DO NOT USE ultrasonic cleaners

Static Electricity:

LEDs are sensitive to electrostatic discharge (ESD). Precautions against ESD must be taken when handling or operating these LEDs. Surge voltage or electrostatic discharge can result in complete failure of the device.

Radiation:

During operation these LEDs do emit **high intensity light**, which is hazardous to skin and eyes, and may cause cancer. Do avoid exposure to the emitted light. **Protective glasses are recommended**. It is further advised to attach a warning label on products/systems.

Operation:

Do only operate LEDs with a current source.

Running these LEDs from a voltage source will result in complete failure of the device. Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

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The above specifications are for reference purpose only and subjected to change without prior notice